

## MOSFET

### 800V CoolMOS™ P7 Power Transistor

The latest 800V CoolMOS™ P7 series sets a new benchmark in 800V super junction technologies and combines best-in-class performance with state of the art ease-of-use, resulting from Infineon's over 18 years pioneering super junction technology innovation.

### **Features**

- $\bullet$  Best-in-class FOM  $R_{DS(on)}\ ^*$   $E_{oss};$  reduced  $Q_g,$   $C_{iss},$  and  $C_{oss}$
- Best-in-class DPAK R<sub>DS(on)</sub>
- Best-in-class  $V_{(GS)th}$  of 3V and smallest  $V_{(GS)th}$  variation of  $\pm 0.5V$
- Integrated Zener Diode ESD protection
- Fully qualified acc. JEDEC for Industrial Applications
- Fully optimized portfolio

### **Benefits**

- · Best-in-class performance
- Enabling higher power density designs, BOM savings and lower assembly costs
- Easy to drive and to parallel
- Better production yield by reducing ESD related failures
- Less production issues and reduced field returns
- Easy to select right parts for fine tuning of designs

### Potential applications

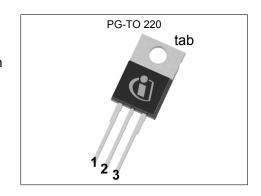
Recommended for hard and soft switching flyback topologies for LED Lighting, low power Chargers and Adapters, Audio, AUX power and Industrial power. Also suitable for PFC stage in Consumer applications and Solar.

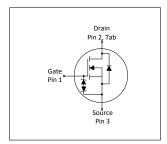
Please note: For MOSFET paralleling the use of ferrite beads on the gate or seperate totem poles is generally recommended.



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|--|-------|------|--|--|--|--|
| Parameter                              | Value | Unit |  |  |  |  |
| V <sub>DS</sub> @ T <sub>j=25°C</sub>  | 800   | V    |  |  |  |  |
| R <sub>DS(on),max</sub>                | 0.60  | Ω    |  |  |  |  |
| $Q_{g,typ}$                            | 20    | nC   |  |  |  |  |
| I <sub>D</sub>                         | 8     | А    |  |  |  |  |
| E <sub>oss</sub> @ 500V                | 2.0   | μJ   |  |  |  |  |
| V <sub>GS(th),typ</sub>                | 3     | V    |  |  |  |  |
| ESD class (HBM)                        | 2     | -    |  |  |  |  |
|  |       |      |  |  |  |  |

| Type / Ordering Code | Package     | Marking  | Related Links  |
|----------------------|-------------|----------|----------------|
| IPP80R600P7          | PG-TO 220-3 | 80R600P7 | see Appendix A |











# 800V CoolMOS™ P7 Power Transistor IPP80R600P7



# **Table of Contents**

| Description                           |
|---------------------------------------|
| Maximum ratings                       |
| Thermal characteristics               |
| Electrical characteristics            |
| Electrical characteristics diagrams 6 |
| Test Circuits                         |
| Package Outlines                      |
| Appendix A                            |
| Revision History                      |
| Trademarks                            |
| Disclaimer                            |

# 800V CoolMOS™ P7 Power Transistor IPP80R600P7



1 Maximum ratings at  $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

| Parameter                                     | O b. a. l                |            | Value | S        | 11   | Note / Took Condition   |
|---|--------------------------|------------|-------|----------|------|---|
|   | Symbol                   | Min.       | Тур.  | Max.     | Unit | Note / Test Condition   |
| Continuous drain current <sup>1)</sup>        | I <sub>D</sub>           | -          | -     | 8<br>5.5 | А    | T <sub>C</sub> =25°C<br>T <sub>C</sub> =100°C                   |
| Pulsed drain current <sup>2)</sup>            | I <sub>D,pulse</sub>     | -          | -     | 22       | Α    | T <sub>C</sub> =25°C  |
| Avalanche energy, single pulse                | <b>E</b> AS              | -          | -     | 20       | mJ   | I <sub>D</sub> =1.4A; V <sub>DD</sub> =50V                      |
| Avalanche energy, repetitive                  | <b>E</b> AR              | -          | -     | 0.17     | mJ   | I <sub>D</sub> =1.4A; V <sub>DD</sub> =50V                      |
| Avalanche current, repetitive                 | I <sub>AR</sub>          | -          | -     | 1.4      | Α    | -   |
| MOSFET dv/dt ruggedness                       | dv/dt                    | -          | -     | 100      | V/ns | V <sub>DS</sub> =0 to 400V                                      |
| Gate source voltage                           | V <sub>GS</sub>          | -20<br>-30 | -     | 20<br>30 | V    | static;<br>AC (f>1 Hz)  |
| Power dissipation                             | P <sub>tot</sub>         | -          | -     | 60       | W    | <i>T</i> <sub>C</sub> =25°C                                     |
| Operating and storage temperature             | $T_{\rm j},~T_{\rm stg}$ | -55        | -     | 150      | °C   | -   |
| Mounting torque                               | -                        | -          | -     | 60       | Ncm  | M3 and M3.5 screws  |
| Continuous diode forward current              | Is                       | -          | -     | 6.2      | Α    | <i>T</i> <sub>C</sub> =25°C                                     |
| Diode pulse current <sup>2)</sup>             | I <sub>S,pulse</sub>     | -          | -     | 22       | Α    | T <sub>C</sub> =25°C  |
| Reverse diode dv/dt <sup>3)</sup>             | dv/dt                    | -          | -     | 1        | V/ns | $V_{\rm DS}$ =0 to 400V, $I_{\rm SD}$ <=1.7A, $T_{\rm j}$ =25°C |
| Maximum diode commutation speed <sup>3)</sup> | di <sub>f</sub> /dt      | -          | -     | 50       | A/μs | $V_{\rm DS}$ =0 to 400V, $I_{\rm SD}$ <=1.7A, $T_{\rm j}$ =25°C |

#### 2 Thermal characteristics

Table 3 Thermal characteristics

| Davamatar  | Cumbal            | Values |      | Unit | Note / Took Condition |                                      |
|--|-------------------|--------|------|------|-----------------------|--------------------------------------|
| Parameter  | Symbol            | Min.   | Тур. | Max. | Unit                  | Note / Test Condition                |
| Thermal resistance, junction - case                        | <b>R</b> thJC     | -      | -    | 2.1  | °C/W                  | -                                    |
| Thermal resistance, junction - ambient                     |                   | -      | -    | 62   | °C/W                  | leaded                               |
| Thermal resistance, junction - ambient for SMD version     | R <sub>thJA</sub> | -      | -    | -    | °C/W                  | n.a.                                 |
| Soldering temperature, wavesoldering only allowed at leads | $T_{sold}$        | -      | -    | 260  | °C                    | 1.6 mm (0.063 in.) from case for 10s |

 $<sup>^{1)}</sup>$  Limited by T<sub>j max</sub>. Maximum duty cycle D=0.5  $^{2)}$  Pulse width t<sub>p</sub> limited by T<sub>j,max</sub>  $^{3)}$  V<sub>DClink</sub>=400V; V<sub>DS,peak</sub><V<sub>(BR)DSS</sub>; identical low side and high side switch with identical R<sub>G</sub>;  $t_{cond}$ <2µs

# 800V CoolMOS™ P7 Power Transistor IPP80R600P7



## 3 Electrical characteristics

at  $T_j$  = 25°C, unless otherwise specified

**Table 4** Static characteristics

| Danier of the state of the stat | Oh a l                |      | Values       |      |      |   |
|--|-----------------------|------|--------------|------|------|---|
| Parameter  | Symbol                | Min. | Тур.         | Max. | Unit | Note / Test Condition   |
| Drain-source breakdown voltage   | V <sub>(BR)DSS</sub>  | 800  | -            | -    | V    | $V_{GS}$ =0V, $I_{D}$ =1mA  |
| Gate threshold voltage   | V <sub>GS(th)</sub>   | 2.5  | 3            | 3.5  | V    | $V_{\rm DS}$ = $V_{\rm GS}$ , $I_{\rm D}$ =0.17mA   |
| Zero gate voltage drain current  | I <sub>DSS</sub>      | -    | -<br>10      | 1 -  | μΑ   | V <sub>DS</sub> =800V, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C<br>V <sub>DS</sub> =800V, V <sub>GS</sub> =0V, T <sub>j</sub> =150°C |
| Gate-source leakage curent incl. zener diode   | I <sub>GSS</sub>      | -    | -            | 1    | μΑ   | V <sub>GS</sub> =20V, V <sub>DS</sub> =0V   |
| Drain-source on-state resistance   | R <sub>DS(on)</sub>   | -    | 0.51<br>1.33 | 0.60 | Ω    | V <sub>GS</sub> =10V, I <sub>D</sub> =3.4A, T <sub>j</sub> =25°C<br>V <sub>GS</sub> =10V, I <sub>D</sub> =3.4A, T <sub>j</sub> =150°C |
| Gate resistance  | <b>R</b> <sub>G</sub> | -    | 1            | -    | Ω    | f=250kHz, open drain  |

Table 5 Dynamic characteristics

| Demonstra  | Or words and                       |      | Values |   |      |  |  |
|--|------------------------------------|------|--------|---|------|--|--|
| Parameter  | Symbol                             | Min. | Тур.   | Max.  | Unit | Note / Test Condition  |  |
| Input capacitance  | C <sub>iss</sub>                   | -    | 570    | -   | pF   | V <sub>GS</sub> =0V, V <sub>DS</sub> =500V, f=250kHz                               |  |
| Output capacitance   | Coss                               | -    | 11     | -   | pF   | V <sub>GS</sub> =0V, V <sub>DS</sub> =500V, f=250kHz                               |  |
| Effective output capacitance, energy related <sup>1)</sup> | ergy $C_{\text{o(er)}}$ - 17 - $p$ |      | pF     | V <sub>GS</sub> =0V, V <sub>DS</sub> =0 to 500V |      |  |  |
| Effective output capacitance, time related <sup>2)</sup>   | C <sub>o(tr)</sub>                 | -    | 252    | -   | pF   | $I_{\rm D}$ =constant, $V_{\rm GS}$ =0V, $V_{\rm DS}$ =0 to 500V                   |  |
| Turn-on delay time   | t <sub>d(on)</sub>                 | -    | 8      | -   | ns   | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =3.4A, $R_{\rm G}$ =10 $\Omega$ |  |
| Rise time  | t <sub>r</sub>                     | -    | 8      | -   | ns   | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =3.4A, $R_{\rm G}$ =10 $\Omega$ |  |
| Turn-off delay time  | $t_{ m d(off)}$                    | -    | 40     | -   | ns   | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =3.4A, $R_{\rm G}$ =10 $\Omega$ |  |
| Fall time  | t <sub>f</sub>                     | -    | 10     | -   | ns   | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =3.4A, $R_{\rm G}$ =10 $\Omega$ |  |

Table 6 Gate charge characteristics

| Parameter             | Cumbal               | Values |      |      | 11   | Nata / Taat Candition                             |
|-----------------------|----------------------|--------|------|------|------|---|
|                       | Symbol Min.          |        | Тур. | Max. | Unit | Note / Test Condition                             |
| Gate to source charge | Q <sub>gs</sub>      | -      | 2    | -    | nC   | $V_{DD}$ =640V, $I_{D}$ =3.4A, $V_{GS}$ =0 to 10V |
| Gate to drain charge  | $Q_{ m gd}$          | -      | 8    | -    | nC   | $V_{DD}$ =640V, $I_{D}$ =3.4A, $V_{GS}$ =0 to 10V |
| Gate charge total     | <b>Q</b> g           | -      | 20   | -    | nC   | $V_{DD}$ =640V, $I_{D}$ =3.4A, $V_{GS}$ =0 to 10V |
| Gate plateau voltage  | V <sub>plateau</sub> | -      | 4.5  | -    | V    | $V_{DD}$ =640V, $I_{D}$ =3.4A, $V_{GS}$ =0 to 10V |

 $<sup>^{1)}</sup>$   $C_{\text{o(er)}}$  is a fixed capacitance that gives the same stored energy as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 500V  $^{2)}$   $C_{\text{o(tr)}}$  is a fixed capacitance that gives the same charging time as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 500V

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IPP80R600P7

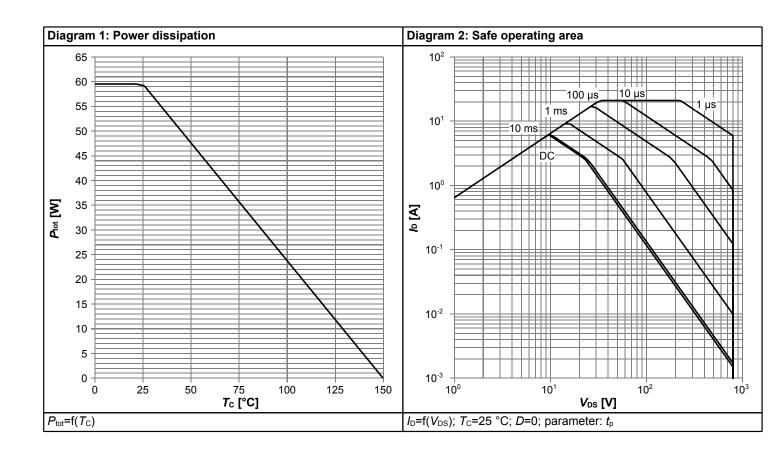


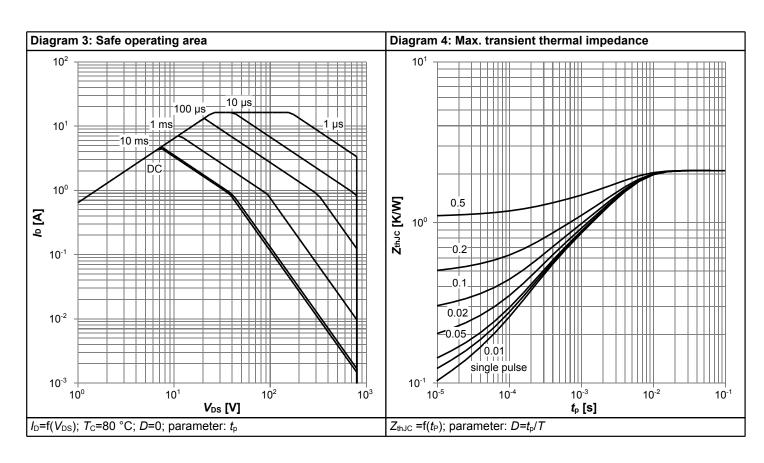
## Table 7 Reverse diode characteristics

| Doromotor                     | Symbol           | Values |                |   | 11:4:4 | Nata / Tast Candition   |  |
|-------------------------------|------------------|--------|----------------|---|--------|---|--|
| Parameter                     | Symbol           | Min.   | Min. Typ. Max. |   | Unit   | Note / Test Condition   |  |
| Diode forward voltage         | V <sub>SD</sub>  | -      | 0.9            | - | V      | V <sub>GS</sub> =0V, I <sub>F</sub> =3.4A, T <sub>f</sub> =25°C                         |  |
| Reverse recovery time         | t <sub>rr</sub>  | -      | 640            | - | ns     | V <sub>R</sub> =400V, I <sub>F</sub> =1.7A, d <i>i</i> <sub>F</sub> /d <i>t</i> =50A/μs |  |
| Reverse recovery charge       | Qrr              | -      | 6              | - | μC     | V <sub>R</sub> =400V, I <sub>F</sub> =1.7A, d <i>i</i> <sub>F</sub> /d <i>t</i> =50A/μs |  |
| Peak reverse recovery current | I <sub>rrm</sub> | -      | 14             | - | Α      | V <sub>R</sub> =400V, I <sub>F</sub> =1.7A, d <i>i</i> <sub>F</sub> /d <i>t</i> =50A/μs |  |

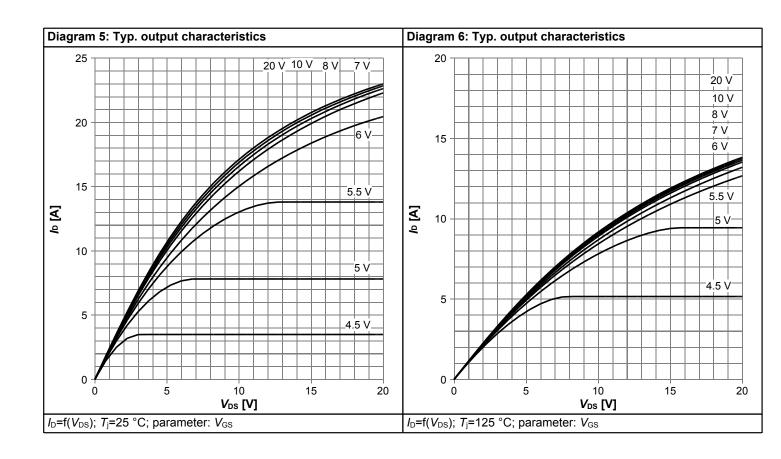


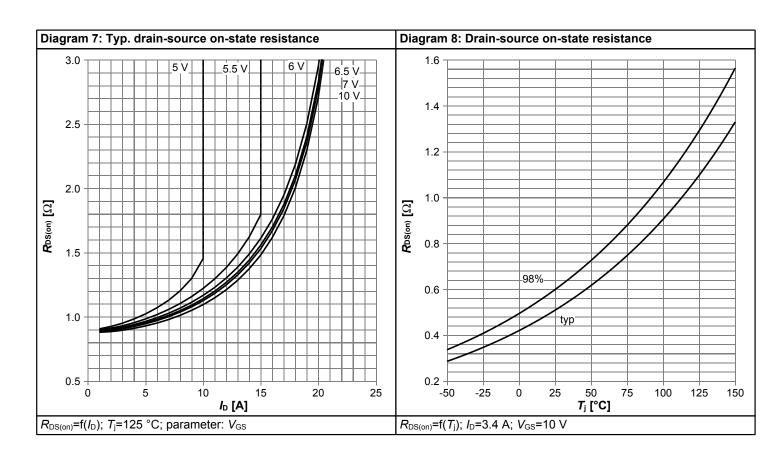
# 4 Electrical characteristics diagrams



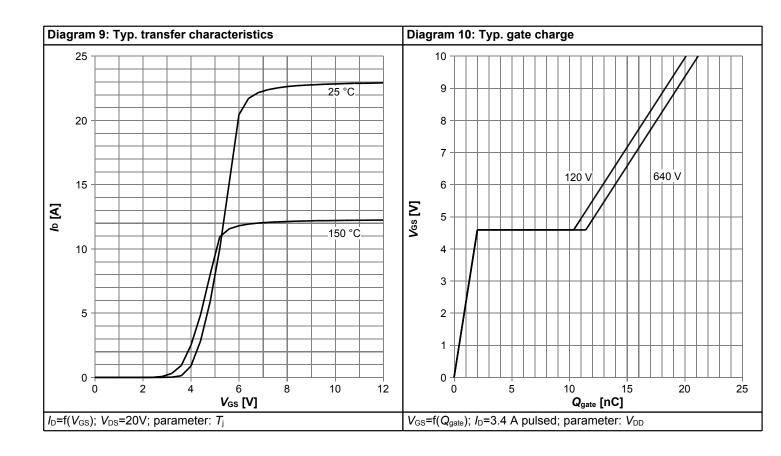


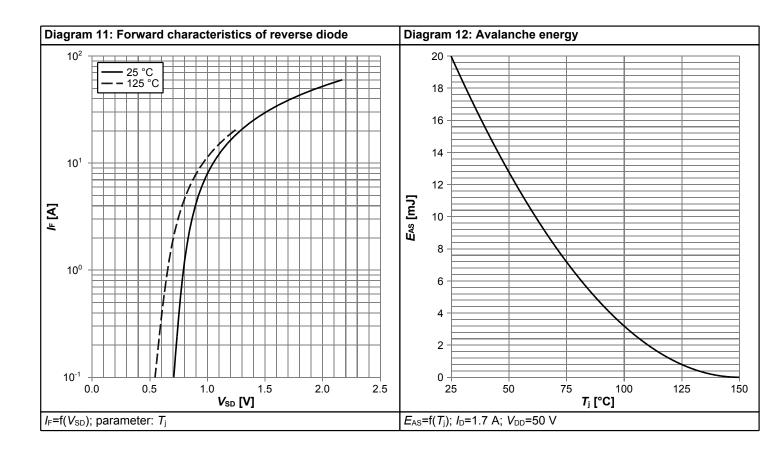




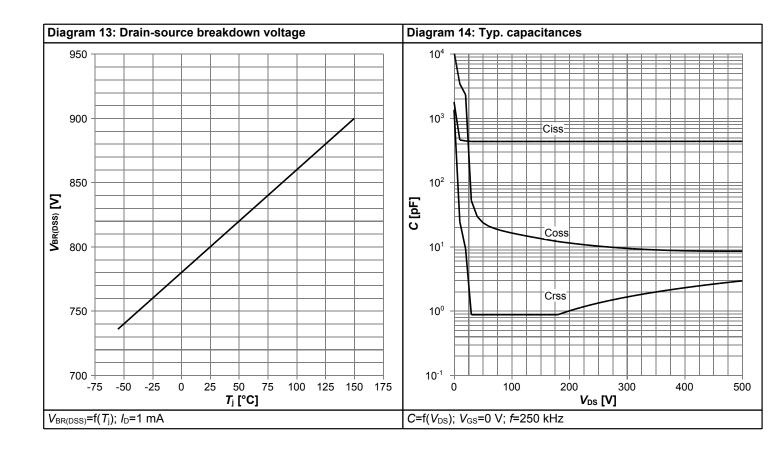


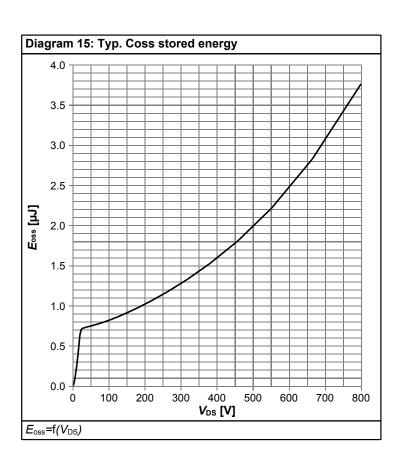














## 5 Test Circuits

**Table 8** Diode characteristics

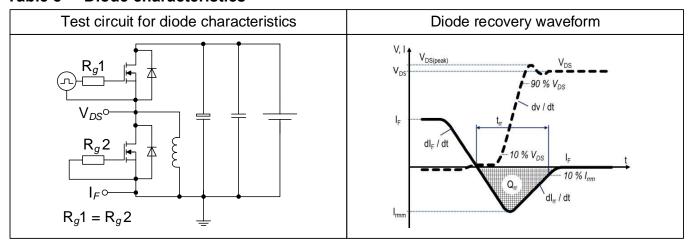
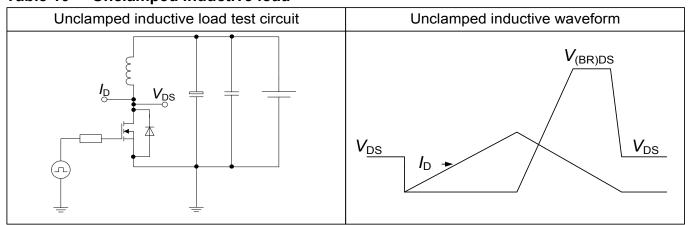


Table 9 Switching times

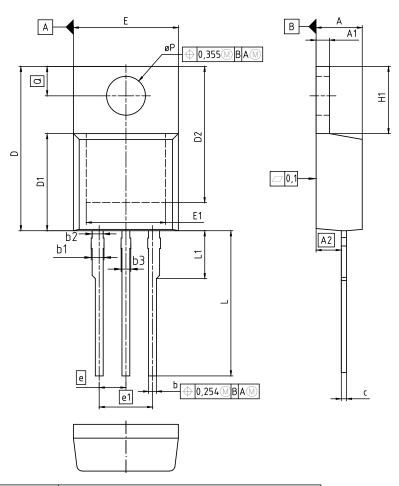


Table 10 Unclamped inductive load





# 6 Package Outlines



| DIM | MILLIN | METERS | INCH  | IES   |  |
|-----|--------|--------|-------|-------|--|
| DIM | MIN    | MAX    | MIN   | MAX   |  |
| Α   | 4.30   | 4.57   | 0.169 | 0.180 |  |
| A1  | 1.17   | 1.40   | 0.046 | 0.055 |  |
| A2  | 2.15   | 2.72   | 0.085 | 0.107 |  |
| b   | 0.65   | 0.86   | 0.026 | 0.034 |  |
| b1  | 0.95   | 1.40   | 0.037 | 0.055 |  |
| b2  | 0.95   | 1.15   | 0.037 | 0.045 |  |
| b3  | 0.65   | 1.15   | 0.026 | 0.045 |  |
| С   | 0.33   | 0.60   | 0.013 | 0.024 |  |
| D   | 14.81  | 15.95  | 0.583 | 0.628 |  |
| D1  | 8.51   | 9.45   | 0.335 | 0.372 |  |
| D2  | 12.19  | 13.10  | 0.480 | 0.516 |  |
| E   | 9.70   | 10.36  | 0.382 | 0.408 |  |
| E1  | 6.50   | 8.60   | 0.256 | 0.339 |  |
| е   | 2.     | 54     | 0.100 |       |  |
| e1  | 5.     | 08     | 0.2   | 200   |  |
| N   |        | 3      | 3     | 3     |  |
| H1  | 5.90   | 6.90   | 0.232 | 0.272 |  |
| L   | 13.00  | 14.00  | 0.512 | 0.551 |  |
| L1  | -      | 4.80   | -     | 0.189 |  |
| øΡ  | 3.60   | 3.89   | 0.142 | 0.153 |  |
| Q   | 2.60   | 3.00   | 0.102 | 0.118 |  |

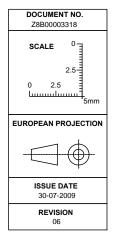


Figure 1 Outline PG-TO 220-3, dimensions in mm/inches

# 800V CoolMOS™ P7 Power Transistor IPP80R600P7



# 7 Appendix A

## Table 11 Related Links

• IFX CoolMOS Webpage: www.infineon.com

• IFX Design tools: www.infineon.com

# 800V CoolMOS™ P7 Power Transistor





### **Revision History**

IPP80R600P7

Revision: 2018-02-13, Rev. 2.1

### **Previous Revision**

| Revision | Date       | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.0      | 2017-05-02 | Release of final version                     |
| 2.1      | 2018-02-13 | Corrected front page text                    |

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